

POOPSIE BOWER TUCK SCHOLARSHIP

The EMA Foundation for Paper-Based Communications proudly presents the Poopsie Bower Tuck Scholarship. The Poopsie Bower Tuck Scholarship, awarded annually in the amount of \$5,000, supports two female members of the envelope manufacturing community who are advancing their education. This one-time scholarship is granted to one high school graduate and one college student continuing her studies. The Poopsie Bower Tuck Scholarship Committee will judge applications.

About Poopsie



Joyce Hamilton, known to all as “Poopsie,” was born on April 12, 1927, in Bradford, PA. After attending the University of Pennsylvania, she moved to California with her parents, where she met and married Nate Bower. In 1964, Nate started Papercone Corporation, a specialty envelope manufacturing company with Poopsie by his side. Poopsie was a great promoter of the industry and EMA, where her friends and industry colleagues became family. After Nate passed, she married John Tuck. The EMA family created This scholarship in her honor after her death on November 28, 2016.

Eligibility Requirements

- A female employee*
- The daughter of an employee*
- The granddaughter of an employee*

*An employee is a member of EMA or a member of the supply chain of the Envelope Manufacturers (NAISC- 322230 Stationery Product Manufacturing). The recipient must be advancing her education in community college, college, university, vocational or technical school. Applicants should have a GPA of 2.8 or better. All applicants must have a High School Diploma or GED.

Application Requirements

- Completed Application
- Recent transcript, including courses and grades earned.
- No more than two typed pages responding to the questions:
How has paper-based communication impacted your life?
What are your goals and aspirations?
- Two letters of recommendation

Deadline

Application materials must be postmarked by **April 1, 2026**, for consideration for the upcoming academic year.

Poopsie Bower Tuck Scholarship Application Form

(Please print)

Last Name: _____ First: _____ M.I. _____

Street: _____

City: _____ State: _____ Zip: _____

Home Phone: _____ Mobile: _____

Email Address: _____

Name of Parents/Guardians: _____

High School/Employer: _____
Name Address

Projected Graduation Date: _____ GPA: _____

Guidance Counselor/Employer Name: _____ Email: _____

University/College, Vocational or Technical School you plan to attend:

Admissions Office Phone: (____) _____

Have you been officially accepted? Yes ☐ No ☐

List all honors received and/or clubs and organizations you participated in at your high school. Please specify your level of involvement, office, or position held if applicable. *If you have a resume, you may submit it instead of the following lists.*

Honors/Organizations	Position Held	Years Participated

Sports Activities	Involvement/Position	Years Participated

Community Involvement	Duties or Responsibility	Years Participated

How are you affiliated to the envelope manufacturing industry? _____

What is the primary field of interest you plan to pursue? _____

ESSAY QUESTIONS. Please answer the essay questions below on *no more than two typed pages*. The essay must be typewritten and double-spaced.

1. How has paper-based communication impacted your life?

2. What are your goals and aspirations?

TRANSCRIPT. Please mail an **official transcript** separately to the address listed below.

RECOMMENDATIONS. Please provide, by mail, one Faculty/Supervisor Letter of Recommendation (*High School Counselor, Teacher, or Supervisor*) and one Community Service Letter of Recommendation (*Program Director, Church Leader, or someone who has observed your non-school/work-related community activities*). **Must be enclosed in a sealed envelope.**

APPLICATION CERTIFICATION:

If awarded a scholarship, I will provide proof of enrollment for the fall semester from the school no later than June 30, 2026. I understand that failure to do so may result in forfeiture of the scholarship award.

I hereby certify that all information provided in this application is complete and accurate to the best of my knowledge. I also understand that falsifying any information provided on my behalf will result in the revocation of any award granted.

Applicant's Signature: _____ **Date:** _____

Application materials must be postmarked by April 1, 2026

Please mail application, transcripts, and recommendations to the following address:

Attn: Scholarship Committee
EMA Foundation
700 S. Washington Street, Suite 260
Alexandria, VA 22314

Deadline April 1, 2026